

# PATENT ASSIGNMENT

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<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Bok Deuk Jeong	05/24/2011
Chan Ju Park	05/24/2011
Sung Min Lee	05/24/2011
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Samsung Electronics Co., Ltd.
<b>Street Address:</b>	416, Maetan-dong, Yeongtong-gu
<b>City:</b>	Suwon-si, Gyeonggi-do
<b>State/Country:</b>	REPUBLIC OF KOREA
<b>Postal Code:</b>	443-742
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	13155120
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(202)315-3758
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Phone:</b>	(202) 429-0020
<b>Email:</b>	email@nsiplaw.com
<b>Correspondent Name:</b>	North Star Intellectual Property Law, PC
<b>Address Line 1:</b>	P.O. Box 34688
<b>Address Line 4:</b>	Washington, DISTRICT OF COLUMBIA 20043
<b>ATTORNEY DOCKET NUMBER:</b>	12000.SMG.1056
<b>NAME OF SUBMITTER:</b>	Nicholas M. Stabler
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**PATENT**  
 REEL: 026403 FRAME: 0952

## ASSIGNMENT

For valuable consideration, we,

Bok-Deuk JEONG	222-902 Sin LG Xi 2cha Apt., Sinbong-dong, Suji-gu, Yongin-si, Gyeonggi-do, Republic of Korea
Chan-Ju PARK	910-1702 Byeokjeokgol 9danji Apt., Yeongtong-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea
Sung-Min LEE	844-1903 Byeokjeokgol 8danji Apt., Yeongtong-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea

hereby assign to:

**SAMSUNG ELECTRONICS CO., LTD.**, a Republic of Korea

corporation/institute/institution having principal executive office(s) or place of business  
at: 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do 443-742, Republic of  
Korea; and

its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of U.S. Patent Application Number 13/155,120 filed 06/07/2011 at the U.S. Patent & Trademark Office signed by us, with title **SEAMLESS APPLICATION INTEGRATION APPARATUS AND METHOD**, and we authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and application serial number of said application when known; this Assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, preliminary statements and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

IN TESTIMONY/WITNESS WHEREOF, we, undersigned inventors (Assignors) intending to be legally bound, have hereto affixed our signatures.

This 24<sup>th</sup> day of May, 2011

Bokdeuk Jeong

Signature: Bok-Deuk JEONG

This 24 day of May, 2011

Chan-Ju Park

Signature: Chan-Ju PARK

This 24 day of May, 2011

Sung-Min Lee

Signature: Sung-Min LEE